



# Method For Determining Failure Rate And Selecting Best Burn-In time

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NOV 19 2003

TECHNOLOGY CENTER 2800

## BACKGROUND OF THE INVENTION

### 1. Field of the Invention

The invention pertains to methods for determining failure rate and selecting best burn-in time, and can have particular application to provide both error range and risk estimation by numerical approach.

### 2. Description of the Prior Art

Accompany with increasing complexity of integrated circuits and increasing difficulties of market contest, quality and reliability of produced integrated circuits is more important than ever. Therefore, how to control qualities of produced integrated circuits, how to estimate failing risk of integrated circuits while they are used by end-users, and how to balance production cost and quality promise are some important challenge of quality department of integrated circuits manufacturers.

In general, the relation between failure rate of integrated circuits and time, both for testing and for application of end-users, usually is a bathtub curve. As shown in FIG. 1, accompanying with the

increase of time (period), the bathtub curve can be divided into infant mortality period, normal life period and wear out period. Whereby, infant mortality period usually corresponds to failure induced by defects of fabrication, and usually lasts about several weeks; normal  
5 life period usually corresponds to some random failures, and usually lasts about twenty years, thirty years or more; wear out period usually corresponds to failure induced by long-time waste, and is continuously increased while time goes by.

10 Because most of integrated circuits will have been replaced with new designs and new technologies before the wear out period is reached, manufactories usually only need to test all produced integrated circuits through the infant mortality period to select all failing integrated circuits that induced by imperfect fabrication. Thus,  
15 all tested integrated circuits are suitable for selling, and the only risk is some random failures. Moreover, elimination of these random failures and prolongation of normal life-time only can be achieved by improvements of fabrication of integrated circuits, but can not be achieved only by operation of quality department.

20 However, owing to limitation of time, it is impossible for the quality department to test all produced integrated circuits through both the infant mortality period and the normal life period, even only through the infant mortality period. As usual, the quality department  
25 only perform a stress test, or called as accelerated test, to test produced integrated circuits through a specific period under a testing environment in which is more harmful and danger for tested integrated circuits, and then the relation between the failure rate and testing time

is measured. Then, in accordance with the difference between the difference between the testing environment and a normal operating environment to estimate the relation between failure rate and real time, in which is the experienced time under the normal environment.

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Indisputably, how to properly and correctly transform the failure rate testing time relation into the failure rate real time relation, is the key about whether failure rate time relation can be properly consulted by the stress test.

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Moreover, almost all well-known arts use mathematical formula to estimate the failure rate relation by some tested datas. For example, the popular mathematical formula is the chi square distribution  $\lambda = \chi^2(2(r+1))B/2t$ . Herein,  $\lambda$  is the failure rate,  $\chi$  is the chi square function,  $r$  is failing number,  $B$  is confidence and  $t$  is time, and value of  $\chi$  is consulted from a pre-established table.

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Significantly, because the failure rate time relation is consulted by formula in accordance with testing records, well-known arts can not avoid following disadvantages: (1) the difference between the experimental value and the theoretical value can not be found by the used formula; (2) the best burn-in time only can be consulted by experience or formula, it can not be consulted by the relation between the best burn-in time and the corresponding risk; (3) the reliability of produced integrated circuits can not be promised by ensuring the estimated value is almost the best value in accordance with the comparison between the experimental value and the theoretical value.

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As a short summary, it is obviously that conventional arts can not efficiently determine the failure rate time relation and select the best burn-in time. Thus, it is necessary to develop a new method to analysis the testing records of the stress test and to effectively improve efficiency of quality department.

## **SUMMARY OF THE INVENTION**

Objects of the present invention at least include providing a numerical method for providing both error range and risk estimation.

Objects of the present invention further comprise providing method for controlling qualities of produced integrated circuits, estimating failing risk of users of produced integrated circuits, and balancing requirements of both production cost and quality promise.

On the whole, one method present by the invention at least includes following basic steps: Method for determining failure rate and selecting a best burn-in time, comprising: provide numerous integrate circuits; performs a life-time testing process, wherein a failure rate testing time relation is established by measuring the life-time of each integrated circuit under a testing environment, wherein an acceleration factor function also is established under the testing environment, the acceleration factor function is related to the relationship between a testing time of the testing environment and a real time of a normal operating environment; performs a simulating process that a testing time function is used to simulate the failure rate testing time relation;

performs a transforming process by using the acceleration factor function to transform the testing time function into a real time function, wherein a knee point of the real time function corresponds to an operation time which is the best burn-in time; and performs an  
5 integrating process to integrate the real time function through a calculating region to consult an accumulated failure rate real time function, wherein the calculating region is a region in which the real time is larger than the best burn-in time.

10 Besides, the invention further comprises that while more than one integrated circuits are failed before the knee point, the method further comprising deleting part of testing records and re-calculating the best burn-in time until only one integrated circuit is fail before the knee point.

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## **BRIEF DESCRIPTION OF THE DRAWINGS**

Preferred embodiments of the invention are described below  
20 with reference to the following accompanying drawings.

FIG. 1 is a brief illustration of the well-known relationship between failure rate and time for integrated circuits;

25 FIG. 2 is a brief flow chart of one preferred embodiment of this invention;

FIG. 3 is a brief flow chart of another preferred

embodiments of this invention; and

FIG. 4A through FIG. 4C are some referring figures for showing how to decide and find required knee point.

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## **DESCRIPTION OF THE PREFERRED EMBODIMENT**

This disclosure of the invention is submitted in furtherance of  
10 the constitutional purpose of the U.S. Patent Laws "to promote the progress of science and useful arts" (Article 1, Section 8).

One major disadvantage of conventional arts that values of  
part used parameters and values of part used functions, such as chi  
15 square function, are consulted from some pre-established tables, especially same pre-determined tables are used to analysis different testing records of different samples. It is indisputable that some external variables, which are not consulted from testing records, are used to calculate the failure rate time relation, and then the failure  
20 rate time relation can not be obtained only by testing records. Aims on previous discussion, the claimed invention presents a way to estimate the failure rate time relation only in accordance with testing records, and then only errors induced by estimating process will be an issue but errors induced by external variables will not be an issue.

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One preferred embodiment is a method for determining failure rate and selecting a best burn-in time. As FIG. 2 shows, the embodiment comprises following essential steps:

As preparing block 21 shows, provides numerous integrate circuits. Whereby, each integrated circuit is similar to other integrated circuits except unavoidable tolerance of fabricating process.

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As life-time testing block 22 shows, performs a life-time testing process to establish a experimental failure rate versus testing time relation by measuring the life-time or failure rate of each said integrated circuit under a testing environment which is well-known as a bathtub experiment having a curve of experiment data with the shape similar to FIG. 1. The bathtub curve can be divided into infant mortality period, normal life period and wear out period. Moreover, an acceleration factor function or an acceleration coefficient function of the bathtub experiment also is established under the testing environment. Moreover, the testing environment is adjusted to let (failure rate)/(unit time) in the testing environment is larger than the (failure rate)/(unit time) in a normal operating environment, and in general it is achieved by increasing working voltage of integrated circuits, increasing temperature, increasing pressure or other ways. Obviously, contents of the acceleration factor function is decided by the difference between the testing environment and the normal operating environment, and the acceleration factor function could be a constant, a linear function or a nonlinear function. Further, as discussed above, the failure rate versus testing time relation can be divided into three periods in according to value of the testing time, the three periods are an infant mortality period, a normal life period and a wear out period.

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As simulating block 23 shows, performs a simulating process that uses a function for curve fitting to simulate the experimental failure rate versus testing time relation. Whereby, the simulating process is adjusted to let an error, such as the least squares method, between the experimental failure rate versus testing time relation and the simulated failure rate versus testing time function is minimized. Moreover, because usually only the infant mortality period and the normal life period must be considered, and also owing to the hint of FIG. 1, the test life function for curve fitting usually is an exponent function, an equation of failure rate and testing time or  $y=at^b$ , wherein a and b are two parameters, y is the failure rate and t is the testing time. The parameters a and b can be obtained from the substitution of experimental data of failure rate and testing time for y and t. The simulated failure rate versus testing time function  $y=at^b$  is then obtained, wherein parameters a and b are obtained from the experimental data of failure rate and testing time.

As transforming block 24 shows, performs a transforming process that uses the acceleration factor function to transform the simulated failure rate versus testing time function into a real failure rate versus operation time function. Whereby the knee point of the real failure rate versus operation time function corresponds to an operation time which is the best burn-in time. Referring to FIG. 1, it is reasonable that while the difference between the simulated failure rate versus testing time function and the real failure rate versus operation time relation is properly minimized by the simulating process, the knee point should corresponds to the end of the infant mortality period and also corresponds to beginning of the normal life period.



As integrating block 25 shows, performs an integrating process that integrates the real failure rate versus operation time function through a calculating region to obtain a yield ratio  $\square$  normal chip number  $\square$  equal to the area under the curve of the real failure rate versus operation time function . Whereby, the calculating region is a region in which the real time is larger than the best burn-in time. Certainly, because integrated circuits usually never are used to the wear out period, it is reasonable that integrating process is stopped while said testing time in which is corresponds by said testing time is located in said wear out period, and then result of the integrating process is the accumulated failure rate during the normal life period.

Obviously, because the claimed invention never uses any mathematical formula also never uses any external parameter which is not obtained from the testing records, and also because the claimed invention is a numerical approach method, it is reasonable that the claimed invention can decide the error range by "try and error" and also can decide the precision of the obtained real failure rate versus operation time function.

Besides, because calculation and application of the knee point is a key point of the claimed invention, and because precision of knee point is directly proportional to cost of the claimed invention. Calculation is further discussed in following paragraphs.

First, the failure rate versus testing time relation is combined by numerous testing records, the failure rate versus real time relation also

is combined by these testing records, and the differences are only the acceleration factor function.

Next, while more than one integrated circuits are failed before a  
5 specific testing time in which is corresponding to the knee point, it  
usually is necessary to perform an optimization process that deletes  
part of testing records and performs corresponding processes. While  
only one integrated circuit is failed before a specific testing time in  
which is corresponding to the knee point, the specific testing time is a  
10 best testing time of these integrated circuits.

For example, while the failure rate versus testing time relation is  
as shown in FIG. 4A that the curve is formed by following testing  
records 6H-12H-18H ...and so on, it is obviously that 12H, the second  
15 testing record, is a good knee point and no other obvious knee point is  
existent, and then the required time function can be consulted from  
following testing records 6H-12H-23H ...and so on. However, while the  
failure rate versus test time relation is as shown in FIG. 4B that curve  
is formed by 6H-12H-18H-24H(knee point)-30H... and so on, or while  
20 the failure rate versus testing time relation is as shown in FIG. 4C that  
curve is formed by 6H-12H-18H(near knee point)-24H(near knee  
point)-30H...and so on, it is necessary to delete the first few testing  
records, for example deleting the 6H and 12H for FIG. 4C and deleting  
6H for FIG. 4D, to let the knee point is the second used testing  
25 recorded. And the time function is calculated while the knee point is  
properly selected.

Without any question, while it is necessary to decrease the

total failure probability that the integrated circuit is used by an end-used during the normal life period, and while at least one testing record is existent after the knee point, it is useful to move the knee backward to prolong the best burn-in time and decrease the normal life  
5 period. Moreover, while advantages of both prolonged best burn-in time and decreased failure probability can not cancel the disadvantages of both increased production cost and quality controlling cost, the claimed invention also provides some trustable information to notice both the produce line and the customers that failure probability only  
10 can be decreased by improvement of fabrication.

Besides, while there is no enough testing records to ensure the precision of the knee point, the claimed invention can be further expanded to test same integrated circuits several times and find the  
15 best knee point by all testing records of all tests.

Although specific embodiments have been illustrated and described, it will be obvious to those skilled in the art that various modifications may be made without departing from what is intended to  
20 be limited solely by the appended claims.